

6A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

FEATURES:

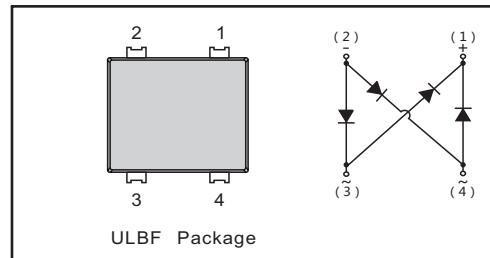
- Glass Passivated Chip Junction
- Reverse Voltage - 800 & 1000 V
- Forward Current - 6.0 A
- High Surge Current Capability
- Designed for Surface Mount Application

MECHANICAL DATA

- Case: ULBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.461g / 0.0163oz

PINNING

PIN	DESCRIPTION
1	Output Anode (+)
2	Output Cathode (-)
3	Input Pin (~)
4	Input Pin (~)



Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	SLBF6K	SLBF6M	Units	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	800	1000	V	
Maximum RMS voltage	V_{RMS}	560	700	V	
Maximum DC Blocking Voltage	V_{DC}	800	1000	V	
Average Rectified Output Current	I_o	6.0			A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	200			A
I^2t Rating for Fusing	I^2t	166			A^2S
Maximum Forward Voltage at 1.0 A	V_F	0.83 (typ.)			V
Maximum Forward Voltage at 6.0 A	V_F	1.0			V
Maximum DC Reverse Current @ $T_A=25^\circ C$ at Rated DC Blocking Voltage @ $T_A=125^\circ C$	I_R	5 100			μA
Typical Junction Capacitance (Note1)	C_j	60			pF
Typical Thermal Resistance (Note2)	R_{\thetaJA} R_{\thetaJC} R_{\thetaJL}	60 10 12			°C/W
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150			°C

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.

Fig.1 Average Rectified Output Current Derating Curve

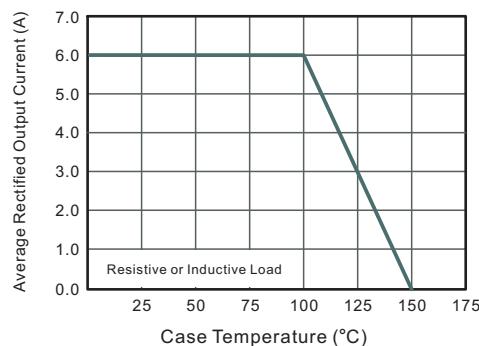


Fig.2 Typical Reverse Characteristics

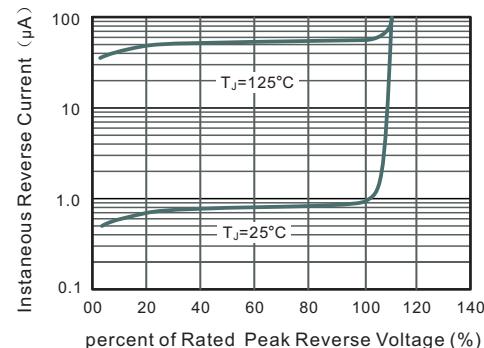


Fig.3 Typical Instantaneous Forward Characteristics

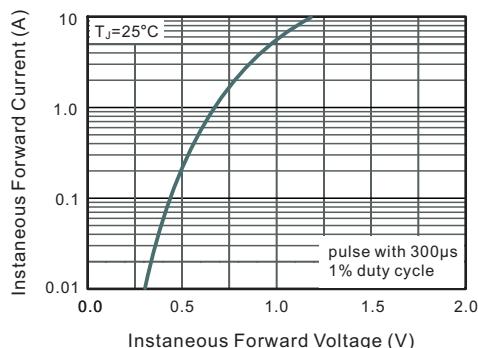


Fig.4 Typical Junction Capacitance

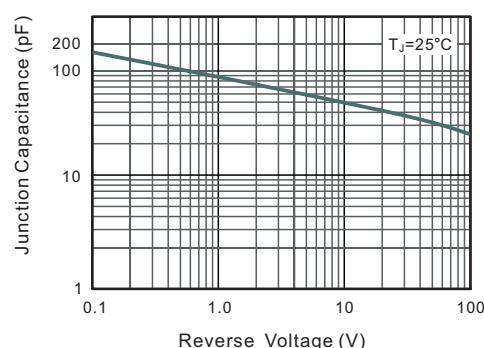


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

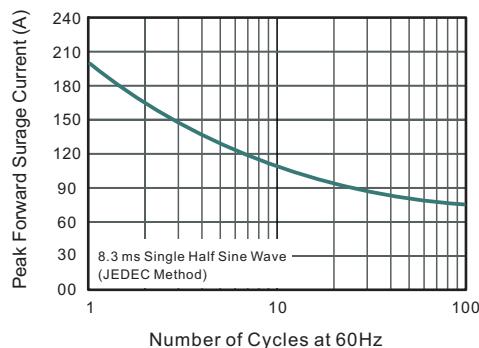
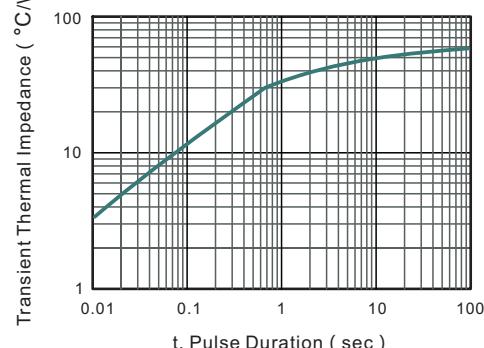


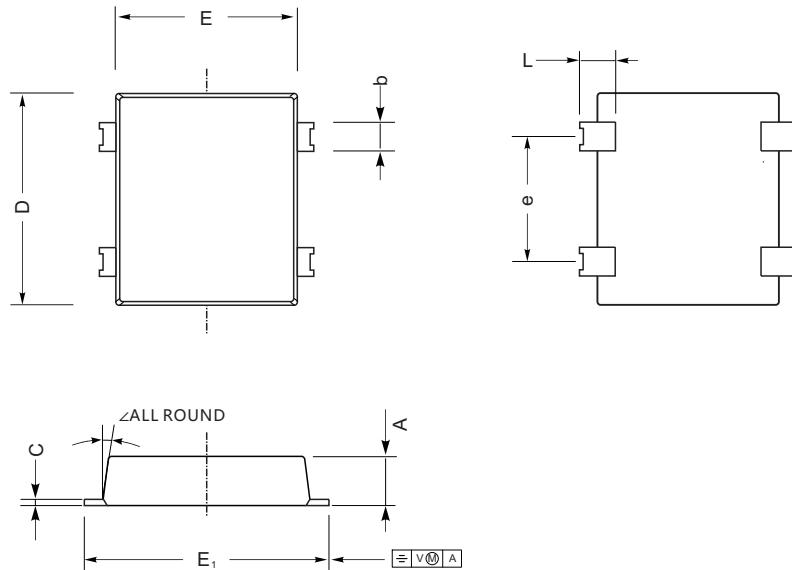
Fig.6- Typical Transient Thermal Impedance



PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

ULBF

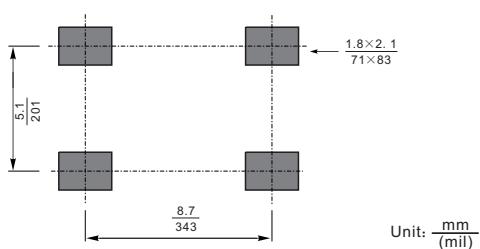


ULBF mechanical data

UNIT		A	C	D	E	E ₁	L	e	b	∠
mm	max	1.75	0.55	9.8	8.8	10.2	1.25	5.3	1.55	10°
	min	1.35	0.25	9.4	8.4	9.8	0.85	4.9	1.25	
mil	max	68	21.6	385	346	401	49	209	61	10°
	min	53	9.8	370	330	385	33	193	49	

The recommended mounting pad size

Marking



Type number	Marking code
SLBF6K	SLBF6K
SLBF6M	SLBF6M